

MEMORANDUM OF UNDERSTANDING

BETWEEN



**K S SCHOOL OF ENGINEERING AND MANAGEMENT
(DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING)**

AND



**Silicon
microsystems**

www.simsindia.net

SILICON MICROSYSTEMS, BENGALURU

On Date: 4th November 2022

This Agreement made and entered into on this 4th day of **November 2022** between **K S SCHOOL OF ENGINEERING AND MANAGEMENT, Bengaluru- 560109** and **SILICON MICROSYSTEMS, Bengaluru - 560004** (hereinafter called "SiMS" which expression shall include its successors and permitted assignees) with its registered office at Bengaluru.

1. OBJECTIVES OF THE MOU

The objective of this Memorandum of Understanding is:

- a. to promote interaction between **K S SCHOOL OF ENGINEERING AND MANAGEMENT** and **SILICON MICROSYSTEMS** in mutually beneficial areas.
- b. to provide a formal basis for initiating interaction between **K S SCHOOL OF ENGINEERING AND MANAGEMENT** and **SILICON MICROSYSTEMS**.

2. PROPOSED MODES OF COLLABORATION

KSSEM AND SIMS propose to collaborate through

- a. Supporting R&D projects, which may be carried out wholly at **KSSEM**
- b. Any other appropriate mode of interaction agreed upon between **KSSEM & SIMS**.

3. FORMS OF RESEARCH AND DEVELOPMENT PROGRAMS

The form of any of the said Research and Development Program (hereinafter referred to as "Research Program") will be subject to a separate Research Agreement entered into by the Parties but may also include the following:

- a. **In their own existing facilities** - The performance of research individually by each Party or concurrently by both Parties in mixed groups at their own facilities with regular exchanges of results.
- b. **In a separate research and development facility** - The performance of research by the technical personnel of both Parties working together in the facilities of one Party or in mixed groups at the facilities supported/ sponsored by either Party.
- c. **Third parties** - The performance of research by the Parties together with one or more third parties.

4. TECHNICAL AREAS OF COLLABORATION

The principal technical areas of collaboration between **K S SCHOOL OF ENGINEERING AND MANAGEMENT** and **SILICON MICROSYSTEMS** will be as follows:

- Assisting to setup Centre of Excellence in Internet of Things (IoT).
- Setting up Skill Lab and to conduct trainings for the students.
- Assisting to setup Centre of Innovation, Incubation and Entrepreneurship



5. AGREEMENTS FOR RESEARCH COLLABORATION

Research undertaken by the **K S SCHOOL OF ENGINEERING AND MANAGEMENT**, the treatment of intellectual property and data rights, including patents, industrial design registration, copyrights and all other proprietary information (including innovations not patented, designs not registered etc.) will be remains to the original inventors and in the college name.

6. CONFIDENTIALITY

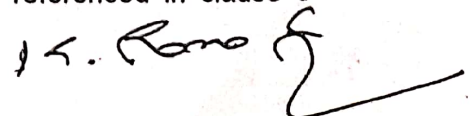
- a. During and for a period of three years from the date of disclosure, each party agrees to consider as confidential all information disclosed by the other party in written or tangible form or, if orally disclosed confirmed in writing within thirty days of disclosure and identified as confidential by the disclosing party.
- b. The obligations above shall not extend to any confidential information for which the receiving party can prove that this information:
 - is in the public domain at the time of disclosure or comes within the public domain without fault of the receiving party.
 - is already known or become known to the receiving party
 - is received from a third party having no obligations of confidentiality to the disclosing party,
 - is independently developed by the receiving party; or
 - is required to be disclosed by law or court order.

7. NON-EXCLUSIVITY

The relationship of the parties under this MOU shall be nonexclusive and both parties, including their affiliates, subsidiaries and divisions, are free to pursue other agreements or collaborations of any kind. However, when entering into a particular research agreement, the participants may agree to limit each party's right to collaborate with others on that subject.

8. TERMS AND TERMINATION

This MOU, unless extended by mutual written agreement of the parties, **shall expire three year** after the effective date specified in the opening paragraph. This MOU may be amended or terminated earlier by mutual written agreement of the parties at any time. Either party shall have the right to unilaterally terminate this MOU upon 30 days prior written notice to the other party. However, no such early termination of this MOU, whether mutual or unilateral, shall affect the obligations of the participants under any Research Agreement, Confidentiality clause as referenced in clause 6



above, or any other agreement entered into pursuant to this MOU, which obligations shall survive any such termination.

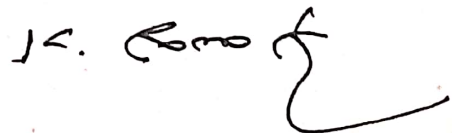
9. RELATIONSHIP

Nothing in this MOU shall be construed to make party a partner, an agent or legal representative of the other for any purpose.

- (a) **Curriculum:** The College will introduce a lab-based course using National Instruments Platform in their undergraduate/Postgraduate engineering curriculum. The college will also explore other ways to streamline the skill lab in their curriculum. Silicon Microsystems will help the college in framing Content for the skill lab with project list.
- (b) **Hands-on-Workshop:** Silicon Microsystems will organize at least one hands-on-workshop on "Embedded System Design", "Intellectual Property Rights", "Incubation and Entrepreneurship" for students and its faculty members as agreed terms and conditions every year. The College will provide the infrastructure facility for conducting such workshop in the campus. Silicon Microsystems will provide certificates for the participants for workshops.
- (c) **Internship:** Silicon Microsystems will short list candidates for internships immediately after 3 day workshop based on their performance and willingness to work on projects.
- (d) **Workshops/Events:** If the College wishes to organize a national event in the area of VLSI, Embedded Systems, Automation, Communication, Machine Learning, Artificial Intelligence, Robotics, IoT Silicon Microsystems will provide speakers.
- (e) **Training Programs:** Silicon Microsystems will assist the college in organizing training programs /tutorials on topics related to VLSI, EMBEDDED, IOT, AUTOMATION & ROBOTICS. Faculty members from the college who have undergone train-the-trainer program and who has certified by their corresponding Industry as trainers may run paid Silicon Microsystems certified training programs. Silicon Microsystems will provide joint certificates for the participants of such programs.

10. ASSIGNMENT

It is understood by the Parties herein this MOU is based on the professional competence and expertise of each party and hence neither Party shall transfer or assign this Agreement, or rights or obligations arising hereunder, either wholly or in part, to any third party.



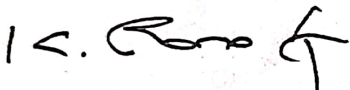
11. SIGNED IN DUPLICATE


This MOU is executed in duplicate with each copy being an official version of the Agreement and having equal legal validity.

BY SIGNING BELOW, the parties, acting by their duly authorized officers, have caused this Memorandum of Understanding to be executed, effective as of the day and year first above written.

On behalf of
**K.S. SCHOOL OF ENGINEERING AND
MANAGEMENT, BENGALURU**

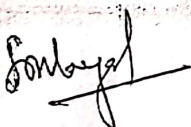
On behalf of
**SILICON MICROSYSTEMS
BENGALURU**

BY: 
DR.K.RAMA NARASIMHA
PRINCIPAL / DIRECTOR

BY: 
M.S.JAYACHANDRA ARADHYA
CEO

4th November 2022
Dr. K. RAMA NARASIMHA
Principal/Director
K S School of Engineering and Management
Bengaluru - 560 109
Witness:

4th November 2022
Witness:

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